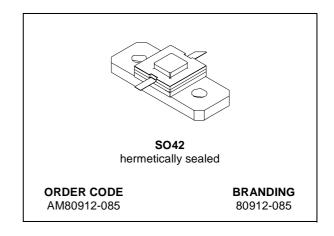


AM80912-085 RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

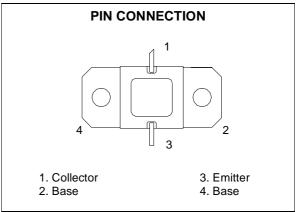
- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 5:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P_{OUT} = 80 W MIN. WITH 7.27 dB GAIN



DESCRIPTION

The AM80912-085 is designed for specialized avionics applications including JTIDS, where power is provided under pulse formats utilizing short pulse widths and high burst or overall duty cycles.

The AM80912-085 is housed in a unique BIG-PACTM Hermetic Metal/Ceramic package with internal input/output impedance matching.



ABSOLUTE MAXIMUM RATINGS (T_{CASE} = 25 °C)

Symbol	Parameter	Value	Unit
P _{DISS}	Power Dissipation [*] ($T_C \le 100 \ ^\circ C$)	300	W
Ι _c	Device Current [*]	8.0	A
V _{cc}	Collector-Supply Voltage*	40	V
Тj	Junction Temperature (Pulsed RF Operation)	250	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

Rth(j-c) Junction -Case Thermal Resistance*	0.75	°C/W
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* Applies only to rated RF amplifier operation

AM80912-085

ELECTRICAL SPECIFICATION (T_{CASE} = 25 °C)

STATIC

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
BV _{CBO}	$I_C = 25 \text{mA}$ $I_E = 0 \text{mA}$	55			V
BV _{EBO}	$I_{C} = 0mA$ $I_{E} = 10mA$	3.5			V
BV _{CER}	$I_{C} = 25 \text{mA}$ $R_{BE} = 10 \Omega$	55			V
ICES	V _{BE} = 0V V _{CE} = 35V			20	mA
h _{FE}	$V_{CE} = 5V$ $I_C = 3A$	20		200	

DYNAMIC

Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Pout	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	80			W
GP	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	7.27			dB
ηс	f = 960 - 1215MHz P _{IN} = 15 W V _{CC} = 35V	35			%

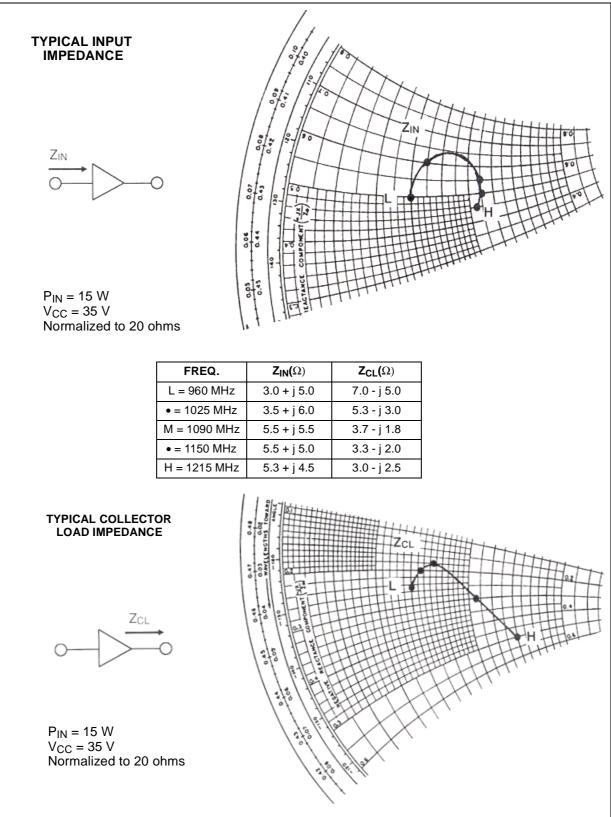
Note: Pulse format: 6.4 μS on 6.6 μS off, repeat for 3.3 ms, then off for 4.5125 ms Duty Cycle: Burst 49.2%, overall 20.8%





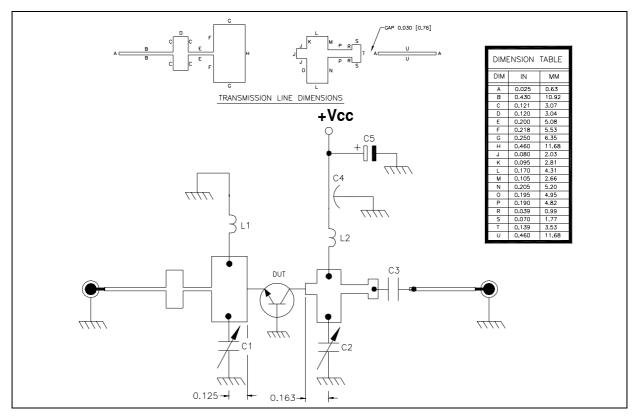
IMPEDANCE DATA

57



3/6

TEST CIRCUIT SCHEMATIC



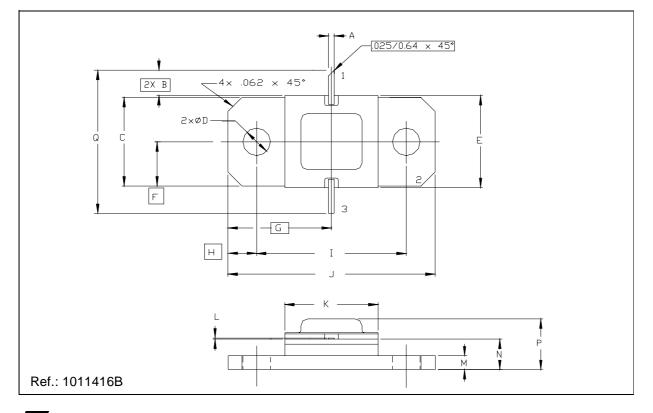
TEST CIRCUIT COMPONENT PART LIST

C1, C2	0.6 - 4.5 pF GIGA-TRIM VARIABLE CAPACITOR
C3	100 pF SURFACE MOUNT CERAMIC CHIP CAPACITOR
C4	1000 pF RESIN SEALED #8-32 THREADED FEEDTHRU CAPACITOR
C5	100 µF / 63 V ALUMINUM ELECTROLYTIC AXIAL LEAD CAPACITOR
L1, L2	INDUCTOR 4 TURNS #26 AWG, ID = 0.0625 [1.58] SOLID TINNED BUS BAR WIRE
PCB	0.025 inch thick Al_2O_3 , $\varepsilon r = 9.6$

57

DIM		mm			Inch	
DIM.	MIN.	TYP.	MAX	MIN.	TYP.	MAX
А	0.51		0.76	0.020		0.030
В		6.35			0.250	
С	9.55		10.06	0.376		0.396
D	2.79		3.30	0.110		0.130
Е	10.03		10.34	0.395		0.407
F		4.90			0.193	
G		11.43			0.450	
Н		3.18			0.125	
Ι	16.26		16.76	0.640		0.660
J	22.61		23.11	0.890		0.910
К	10.03		10.54	0.395		0.415
L	0.10		0.18	0.004		0.006
М	1.32		1.83	0.052		0.072
Ν	2.84		3.35	0.112		0.132
Р			5.84			0.230
Q	22.35		23.37	0.880		0.920

SO42 (.400 X .400 2/L HERM. W/FLG.) MECHANICAL DATA



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6/6

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